

THIS DRAWING CONTAINS INFORMATION WHICH IS THE PROPRIETARY PROPERTY OF MICROSOFT CORPORATION. THIS DRAWING IS RECEIVED IN CONFIDENCE AND ITS CONTENTS MAY NOT BE DISCLOSED WITHOUT THE PRIOR WRITTEN CONSENT OF MICROSOFT CORPORATION.

REVISIONS							
REV	DESCRIPTION	DFT	DATE	CHK	DATE	APVD	DATE

- NOTES: UNLESS OTHERWISE SPECIFIED:
1. ASSEMBLE BOARD PER IPC-A-610(LATEST REVISION) STANDARD.
 2. HANDLE MOISTURE SENSITIVE DEVICES(MSD) PER MANUFACTURERS CALLOUT ON MSD LABEL. IF MSD LABEL IS MISSING OR NOT LEGIBLE THEN ALL PLASTIC PACKAGED COMPONENTS ARE TO BE CONSIDERED MSD LEVEL 6 AND USE EIA/JEP 113-A FOR HANDLING.
 3. USE IPC-7711/7721 (LATEST REVISION) FOR ALL PCBA REWORK.
 4. SQUARE PADS DENOTE THE FOLLOWING:
PIN 1 OF IC'S AND CONNECTORS.
POSITIVE END OF POLARIZED CAPACITORS.
CATHODE END OF DIODES.
 5. PIN IN PASTE (pip) AND WAVE SOLDER PROCESSES WILL BE USED ON THE ANCOR PINS FOR REF DES J7A1 AND J8A1 - SOLDER PASTE WILL BE OVERPRINTED ON SOLDER MASK.

PRIMARY SIDE

UNLESS OTHERWISE SPECIFIED: 1. DIMENSIONS ARE IN INCHES 2. BREAK ALL SHARP EDGES 3. DO NOT SCALE DRAWING 4. TOLERANCES -ANGLES +/- -XXX +/- -XXX +/-		SIGNATURE	DATE	Microsoft 1 MICROSOFT WAY REDMOND WASH 98052-6399 TITLE PCB ASSEMBLY DRAWING, TOP KIEF RETAIL FAB A (OSP) SIZE D DCLC CLASS CODE DOCUMENT NUMBER M1087066-001 A SCALE: NONE SHEET 1 OF 2	
		DRN BY: B.GRAYDON	04/24/18		
		CHK BY:			
		ENGR APVD			
		APVD			